

MH248 Hall-effect sensor is a temperature stable, stress-resistant, micro-power switch. Superior high-temperature performance is made possible through a dynamic offset cancellation that utilizes chopper-stabilization. This method reduces the offset voltage normally caused by device over molding, temperature dependencies, and thermal stress.

MH248 includes the following on a single silicon chip: voltage regulator, Hall voltage generator, small-signal amplifier, chopper stabilization, Schmitt trigger, open-drain output. Advanced CMOS wafer fabrication processing is used to take advantage of low-voltage requirements, component matching, very low input-offset errors, and small component geometries.

This device requires the presence of omni-polar magnetic fields for operation.

MH248 is rated for operation between the ambient temperatures -40° C and $+85^{\circ}$ C for the E temperature range. The four package styles available provide magnetically optimized solutions for most applications. Package types SO is an SOT-23(1.1 mm nominal height),SQ is an QFN2020-3(0.5 mm nominal height),Tsot-23 is an ST(0.7 mm nominal height) ,a miniature low-profile surface-mount package, while package UA is a three-lead ultra-mini SIP for through-hole mounting.

The package type is in a lead Halogen Free version was verified by third party Lab.

Features and Benefits

- CMOS Hall IC Technology
- Solid-State Reliability
- Micro power consumption for battery-powered applications
- Omni polar, output switches with absolute value of North or South pole from magnet
- Operation down to 2.5 V and Max at 3.5V.
- High Sensitivity for direct reed switch replacement applications
- Multi Small Size option
- Custom sensitivity selection is available in optional package.
- Pb Free/Green chip is qualified by third party lab.

Applications

- Solid state switch
- Handheld Wireless Handset Awake Switch (Flip Cell/PHS Phone/Note Book/Flip Video Set)
- Lid close sensor for battery powered devices
- Magnet proximity sensor for reed switch replacement in low duty cycle applications



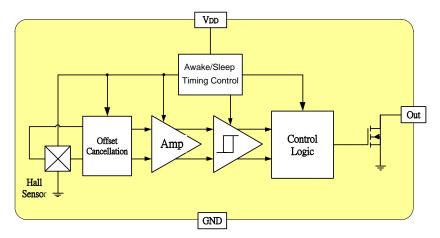
Ordering Information

XXXXXXXXX - X	Company Name and Product Category MH:MST Hall Effect/MP:MST Power IC		
Company Name and Product Category	Part number 181,182,183,184,185,248,249,276,477,381,381F,381R,382 If part # is just 3 digits, the forth digit will be omitted. Temperature range E: 85 °C, I: 105 °C, K: 125 °C, L: 150 °C Package type UA:TO-92S,VK:TO-92S(4pin),VF:TO-92S(5pin),SO:SOT-23, SQ:QFN-3,ST:TSOT-23,SN:SOT-553,SF:SOT-89(5pin), SS:TSOT-26,SD:DFN-6 Sorting α, β ,Blank		

Part No.	Temperature Suffix	Package Type
MH248EUA	$E (-40^{\circ}C \text{ to } + 85^{\circ}C)$	UA (TO-92S)
MH248ESO	$E (-40^{\circ}C \text{ to } + 85^{\circ}C)$	S0 (SOT-23)
MH248EST	$E (-40^{\circ}C \text{ to } + 85^{\circ}C)$	ST (TS0T-23)
MH248ESQ	$E (-40^{\circ}C \text{ to } + 85^{\circ}C)$	SQ (QFN2020-3)
MH248ESO- α	$E (-40^{\circ}C \text{ to } + 85^{\circ}C)$	S0 (SOT-23)
MH248ESO- <i>β</i>	$E (-40^{\circ}C \text{ to } + 85^{\circ}C)$	S0 (SOT-23)
MH248ESO- γ	E $(-40^{\circ}\text{C} \text{ to} + 85^{\circ}\text{C})$	SO (SOT-23)

Custom sensitivity selection is available by MST sorting technology

Functional Diagram



Note: Static sensitive device; please observe ESD precautions. Reverse V_{DD} protection is not included. For reverse voltage protection, a 100 Ω resistor in series with V_{DD} is recommended.



Absolute Maximum Ratings At (Ta=25 °C)

Characteristics		Values	Unit
Supply voltage,(VDD)		5	V
Output Voltage,(Vout)		5	V
Reverse voltage, (VDD) (VOUT)		-0.3	V
Magnetic flux density		Unlimited	Gauss
Output current(<i>Iour</i>)		2	mA
Operating temperature range, (<i>Ta</i>)		-40 to +85	°C
Storage temperature range, (<i>Ts</i>)		-55 to +150	°C
Maximum Junction Temp,(<i>Tj</i>)		150	°C
Thermal Resistance	(θ_{IA}) UA / SO / ST / SQ	206 / 543 / 310 / 543	°C/W
	$(heta_{\scriptscriptstyle JC})$ UA / SO / ST /SQ	148 / 410 / 223 / 410	°C/W
Package Power Dissipation, (P_D) UA / SO / ST / SQ		606 / 230 / 400 / 230	mW

Note: Exceeding the absolute maximum ratings may cause permanent damage. Exposure to absolute maximumrated conditions for extended periods may affect device reliability.

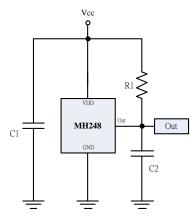
Electrical Specifications

DC Operating Parameters $T_A=+25$ °C, $V_{DD}=3.0V$

Paramete	ers	Test Conditions	Min	Тур	Max	Units
Supply Voltage,(V _{DD})		Operating	2.5		3.5	V
Supply Current,(<i>I</i> _{DD})		Awake State		2.5	4.0	mA
		Sleep State		8.0	12	μΑ
		Average		10	16	μΑ
Output Leakage Current,(Ioff)		Output off			1	uA
Output Low Voltage	$e,(V_{sat})$	Iout=1mA			0.3	V
Awake mode time,(<i>Taw</i>)		Operating		70		uS
Sleep mode time,(<i>T</i>	ΓsL)	Operating		70		mS
Duty Cycle,(<i>D</i> , <i>C</i>)				0.1		%
Operate Point,	(Bops)	S pole to branded side, B > BOP, Vout On	6		60	Gauss
	(BOPN)	N pole to branded side, B > BOP, Vout On	-60		-6	
Release Point	(B_{RPS})	S pole to branded side, B < BRP, Vout Off	5		59	Gauss
	(B_{RPN})	N pole to branded side, B < BRP, Vout Off	-60		-5	
Hysteresis, (BHYS)		BOPx - BRPx		7		Gauss



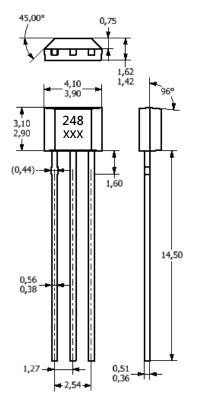
Typical Application circuit



C1 : 10nF C2 : 100pF R1 : 100KΩ

Sensor Location, Package Dimension and Marking MH248 Package

UA Package



NOTES:

Controlling dimension:
mm 2).Leads must be free

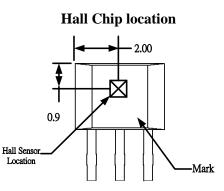
of flash

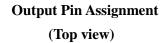
and plating voids

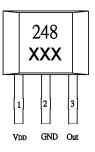
3).Do not bend leads within1 mm of lead to package interface.

4).PINOUT:

- Pin 1VDDPin 2GND
- PIII 2 GIND
- Pin 3 Output

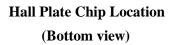


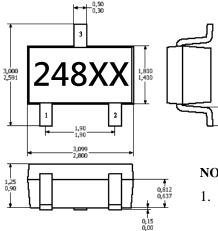






SO Package (Top View)



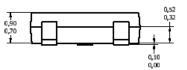


NOTES:

0,60 0,30

- 1. PINOUT (See Top View at left :)
 - $Pin \ 1 \qquad V_{DD}$
 - Pin 2 Output
 - Pin 3 GND
- 2. Controlling dimension: mm
- 3. Lead thickness after solder plating will be 0.254mm maximum

ST Package (TSOT-23) (Top View)

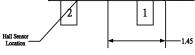


NOTES:

1. PINOUT (See Top View at left:)

Hall Se

- Pin 1 VDD
- Pin 2 Output
- Pin 3 GND
- 2. Controlling dimension: mm;



Hall Plate Chip Location

3

(Bottom view)

1

L.45

3

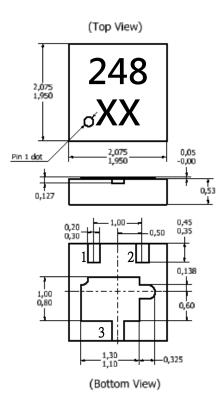
0.80

l i D J

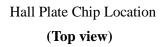


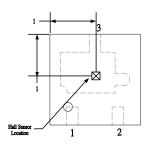
MH248SpecificationsMicropower Hall Effect Switch

SQ Package



- NOTES:
- 3. PINOUT (See Top View
 - at left)
 - Pin 1 VDD
 - Pin 2 Output
 - Pin 3 GND
- Controlling dimension: mm;
- 5. Chip rubbing will be 10mil maximum;
- 6. Chip must be in PKG. center.





X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Industrial Hall Effect/Magnetic Sensors category:

Click to view products by Magnesensor manufacturer:

Other Similar products are found below :

GT-14114GT-14123GTN2C15CGT-12076GT-14049GT-14067GT-14132GT-18030MZ07A108PST360G2-1S-C0000-ERA360-05KMZC1-2V2PS-KP0PSC360G2-F1P-C0000-ERA360-05K-200115L 9E 502W06017115L 5,2E 502W06017115L 14E 502W06017103SR14A-155100-3H-04-AMZT7-03VPS-KW0MZT8-03VPS-KW0A1326LLHLT-TACS770LCB-100U-PFF-T55505-00-02-BGN55.2-ND-15-3GN 55.2-ND-18-3GN 55.2-ND-4-3GN 55.2-ND-8-3GN 55.2-SC-10-3GN 55.4-ND-10-7,5-2GN 55.4-ND-12-9,5-2,5GN55.4-ND-26-20,3-5GN 55.4-ND-7,5-4-1,5101MG7-BP103SR18-1A1324LUA-TMXM1120KITMXM1120SOKITA3212EUA-TAA006-02E55140-3H-03-A55100-2M-02-AMM12-60APS-ZUKACX04-F99-I-V15GN 55.1-SC-24-11.5-4MZA70155MZR40158PW520000ADH025-00EMZT7-03VPS-KP0MZT8-03VPS-KR0MZT8-03VPS-KP0MZT8-03VPS-KP0